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(54) **SOLAR PANEL**

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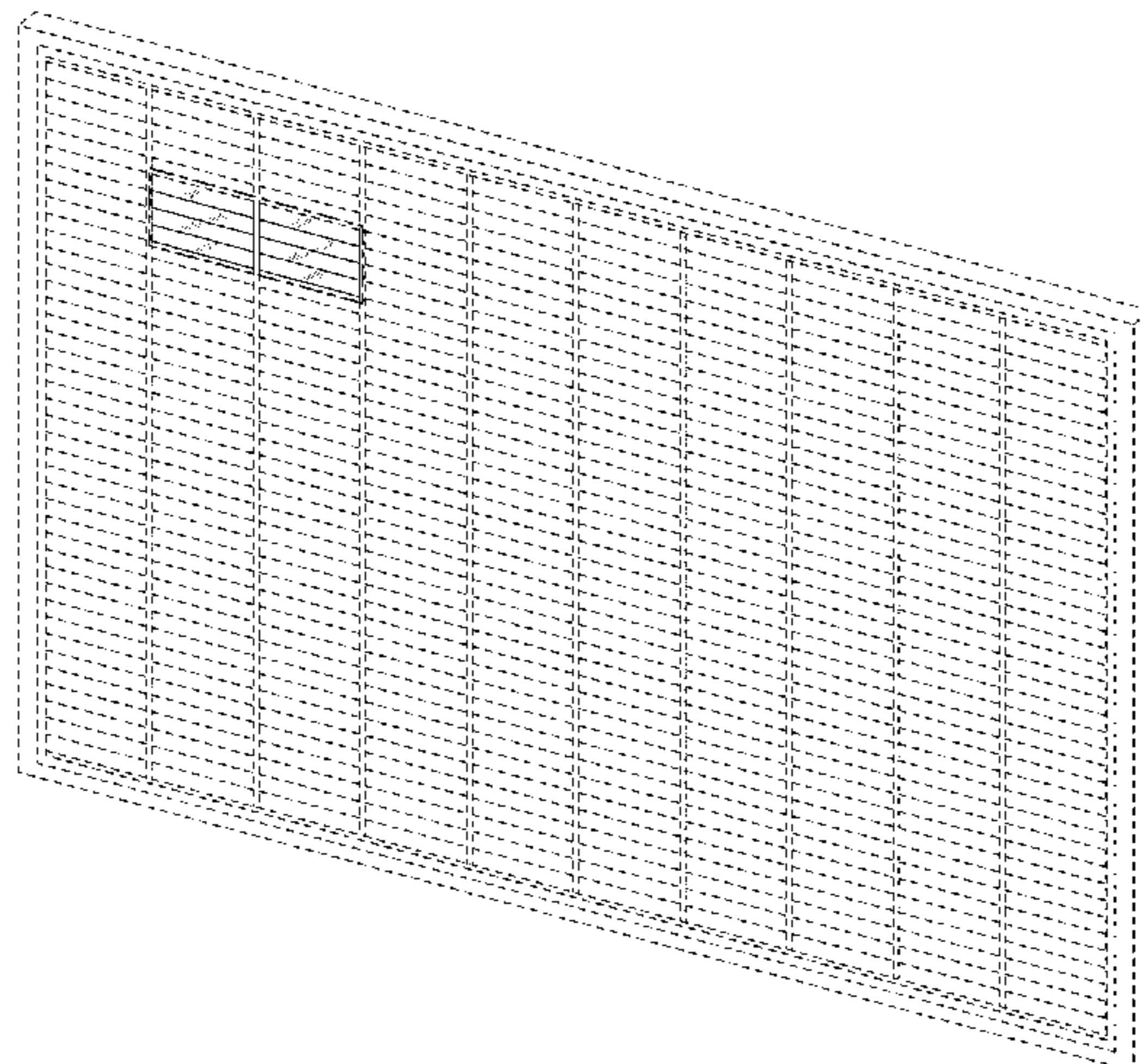
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(57)

## CLAIM

The ornamental design for a solar panel, as shown and described.

## DESCRIPTION

FIG. 1 is a front, top, and right side perspective view of a first embodiment of a solar panel;

FIG. 2 is a front elevational view thereof, the rear elevational view forms no part of the claimed design;

FIG. 3 is a top plan view thereof, the bottom plan view being a mirror image of the top plan view shown;

FIG. 4 is a left side elevational view thereof, the right side elevational view being a mirror image of the left side elevational view shown;

FIG. 5 is a detail front elevational view of the portion thereof within the dot-dash annotation lines;

FIG. 6 is a detail view along line 6-6 in FIG. 5 of the overlapping cells thereof;

FIG. 7 is a front elevational view of a second embodiment of a solar panel, the rear elevational view forms no part of the claimed design;

FIG. 8 is a top plan view thereof, the bottom plan view being a mirror image of the top plan view shown;

FIG. 9 is a left side elevational view thereof, the right side elevational view being a minor image of the left side elevational view shown;

FIG. 10 is a detail front elevational view of the portion thereof within the dot-dash annotation lines;

FIG. 11 is a detail view along line 11-11 in FIG. 10 of the overlapping cells thereof;

FIG. 12 is a front elevational view of a third embodiment of a solar panel, the rear elevational view forms no part of the claimed design;

FIG. 13 is a top plan view thereof, the bottom plan view being a mirror image of the top plan view shown;

FIG. 14 is a left side elevational view thereof, the right side elevational view being a minor image of the left side elevational view shown;

FIG. 15 is a detail front elevational view of the portion thereof within the dot-dash annotation lines; and,

FIG. 16 is a detail view along line 16-16 in FIG. 15 of the overlapping cells thereof.

The broken lines shown represent portions of the solar panel that form no part of the claimed design. The dot-dash broken lines represent annotation lines. None of the broken lines form any part of the claimed design.

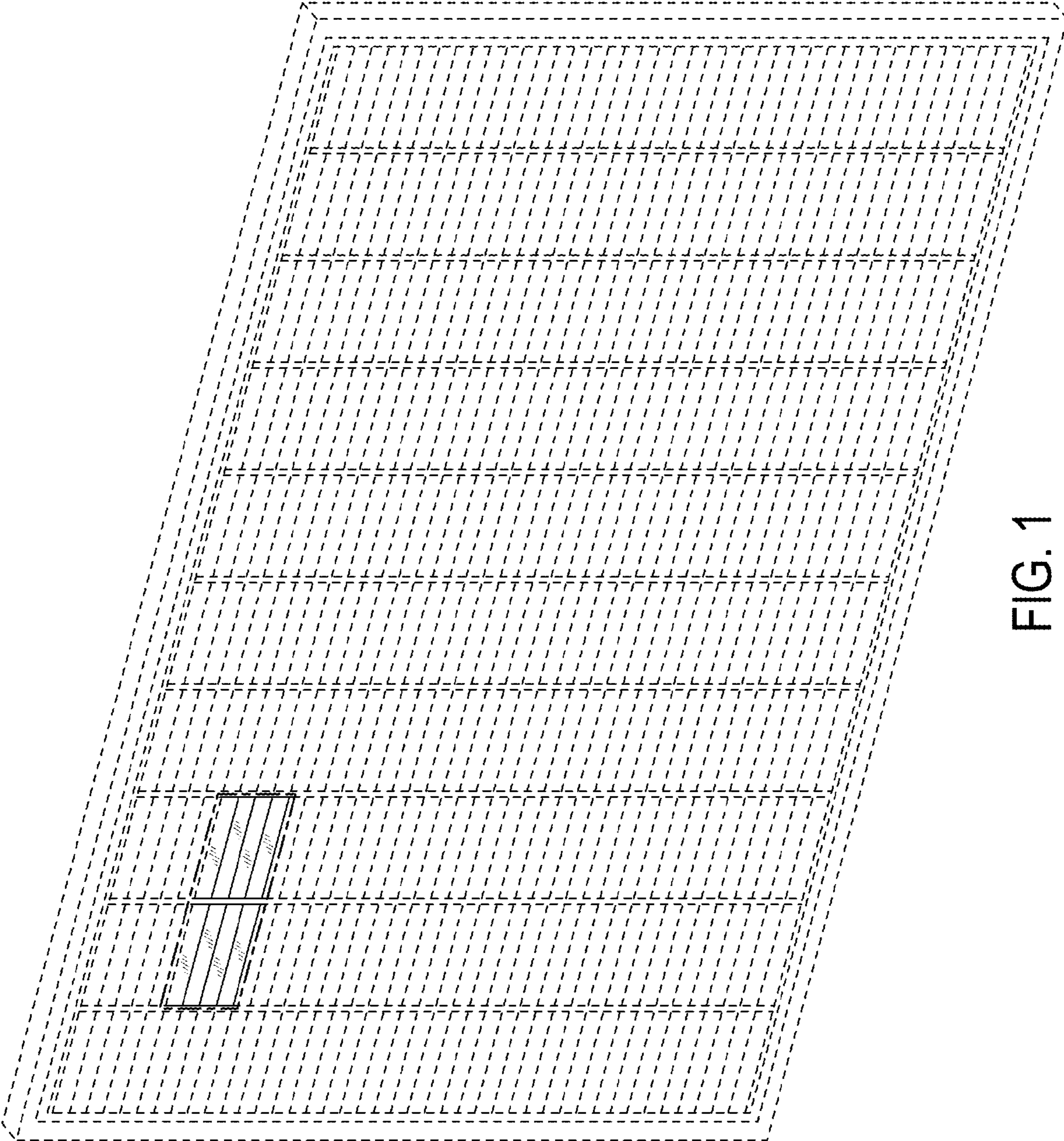


FIG. 1

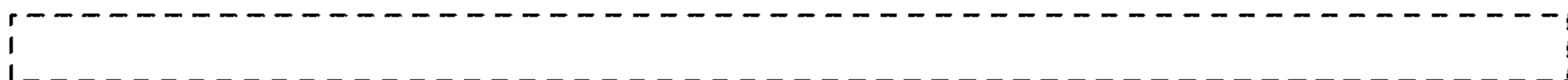


FIG. 4

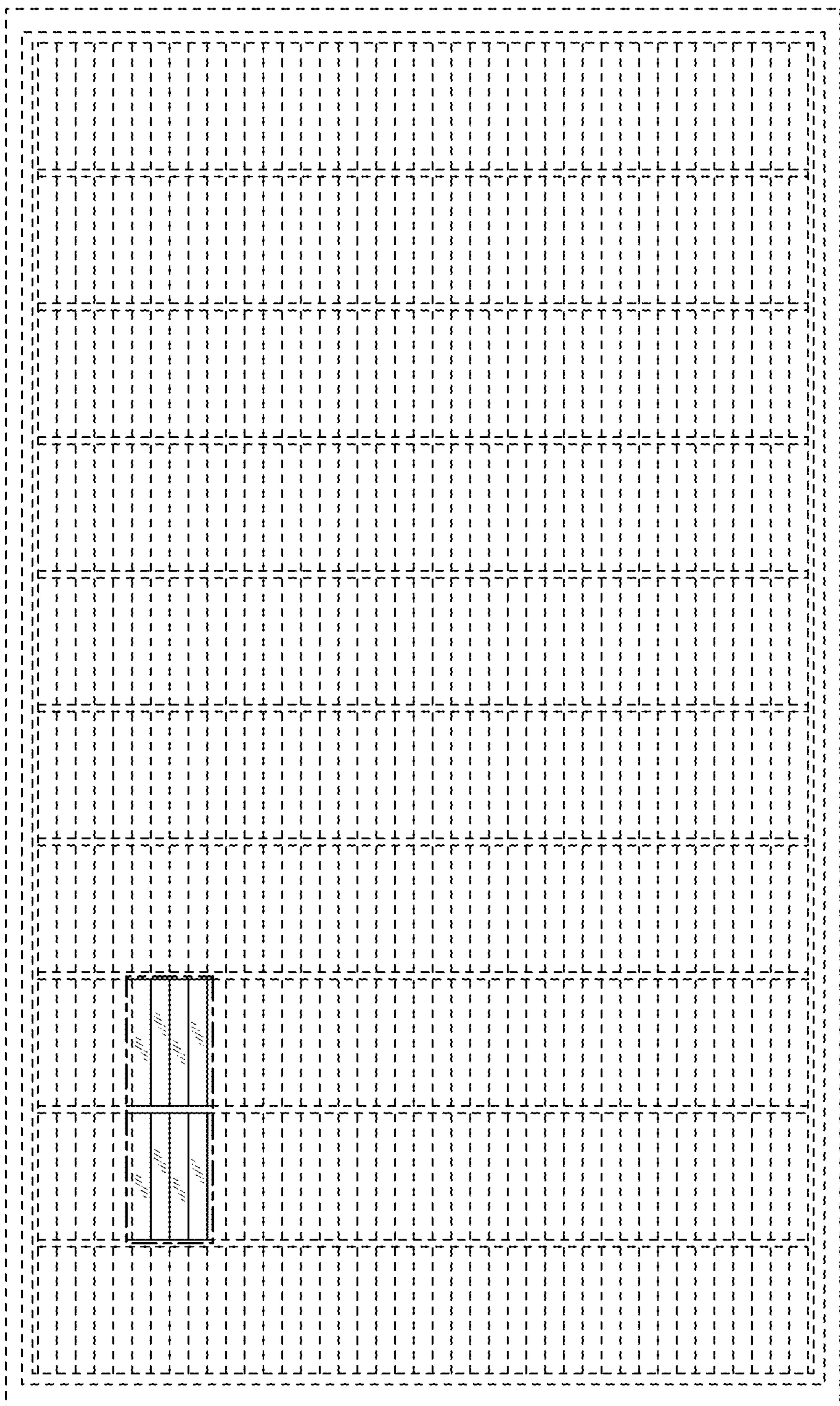


FIG. 2

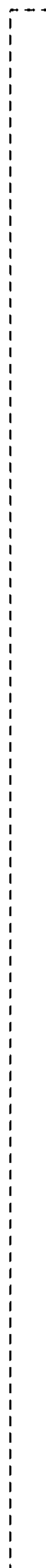


FIG. 3

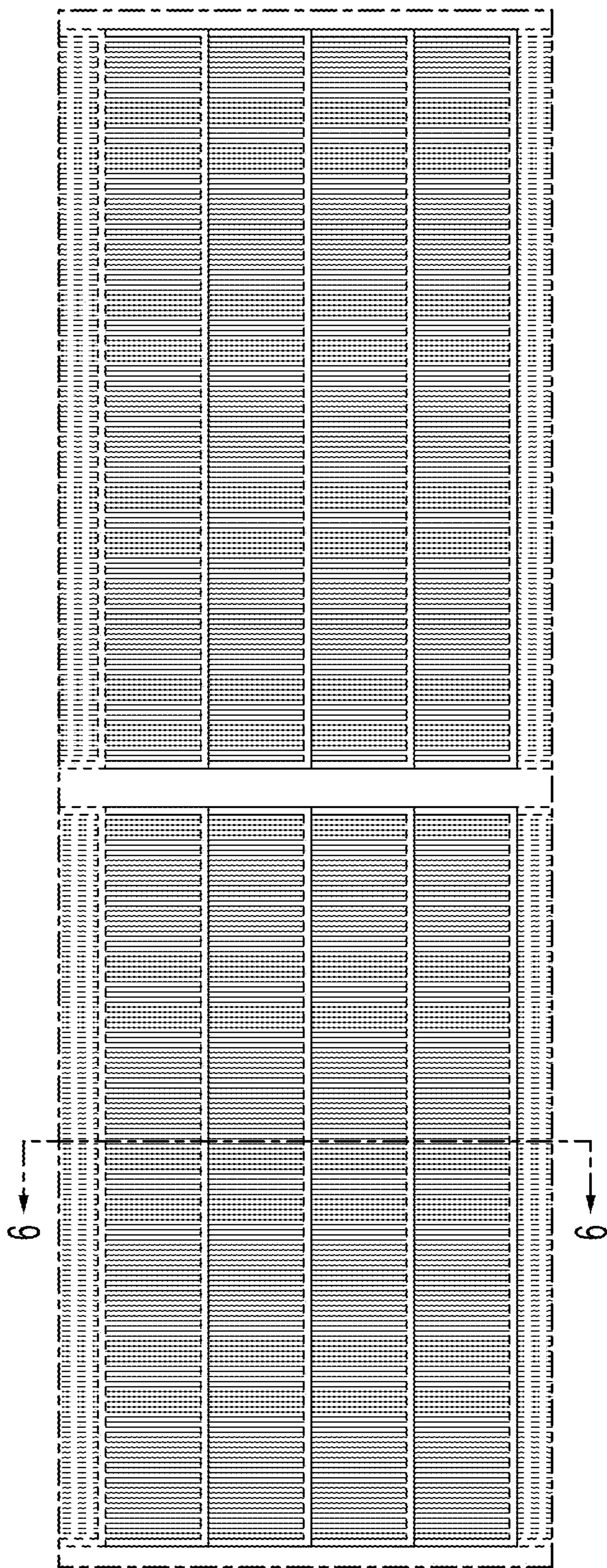


FIG. 5



FIG. 6

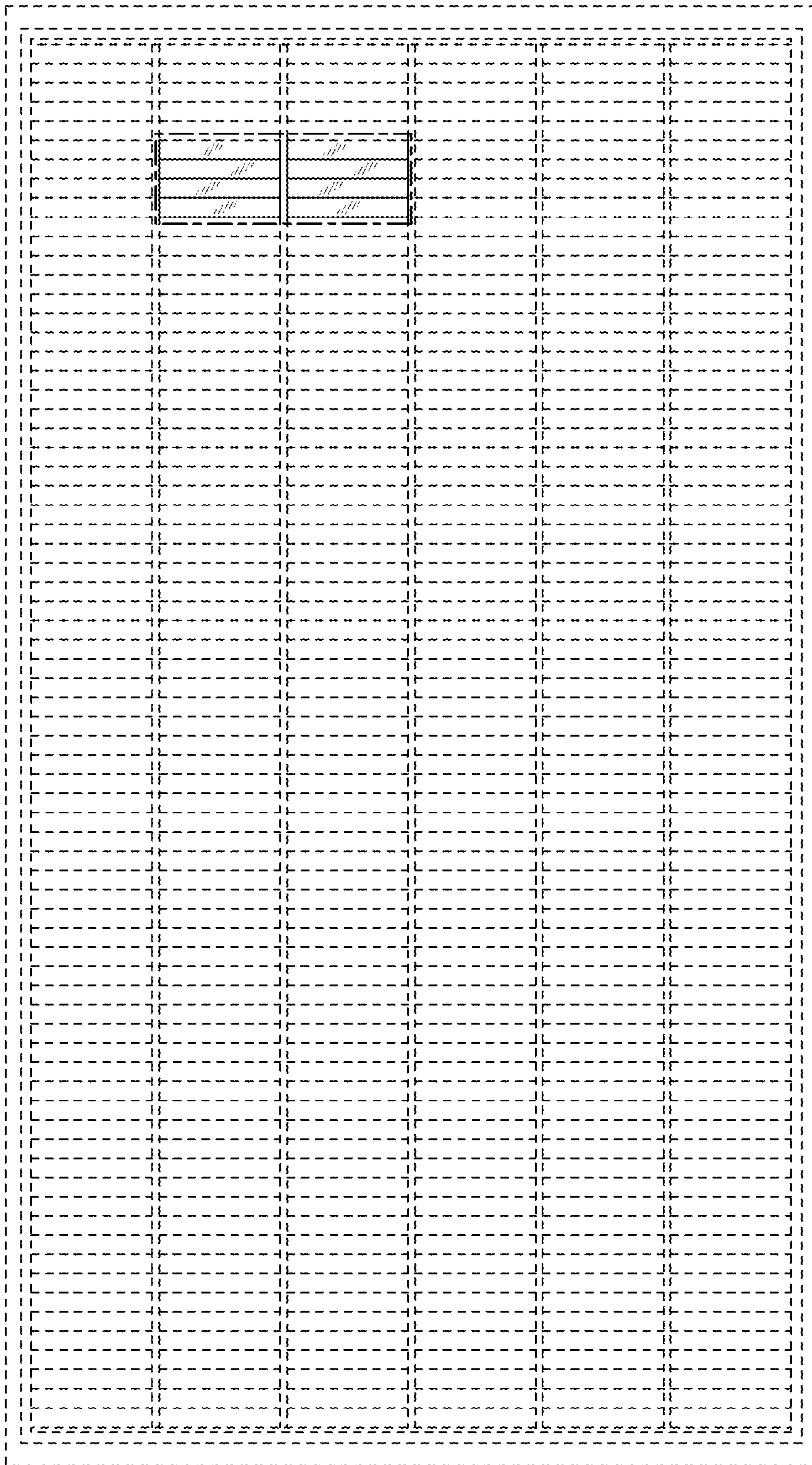


FIG. 7

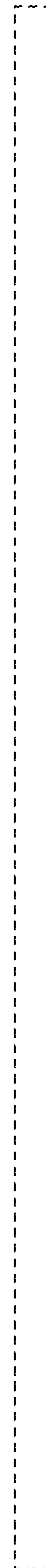


FIG. 9

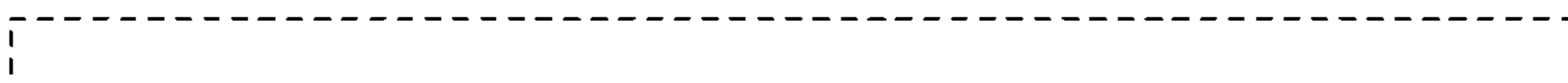


FIG. 8



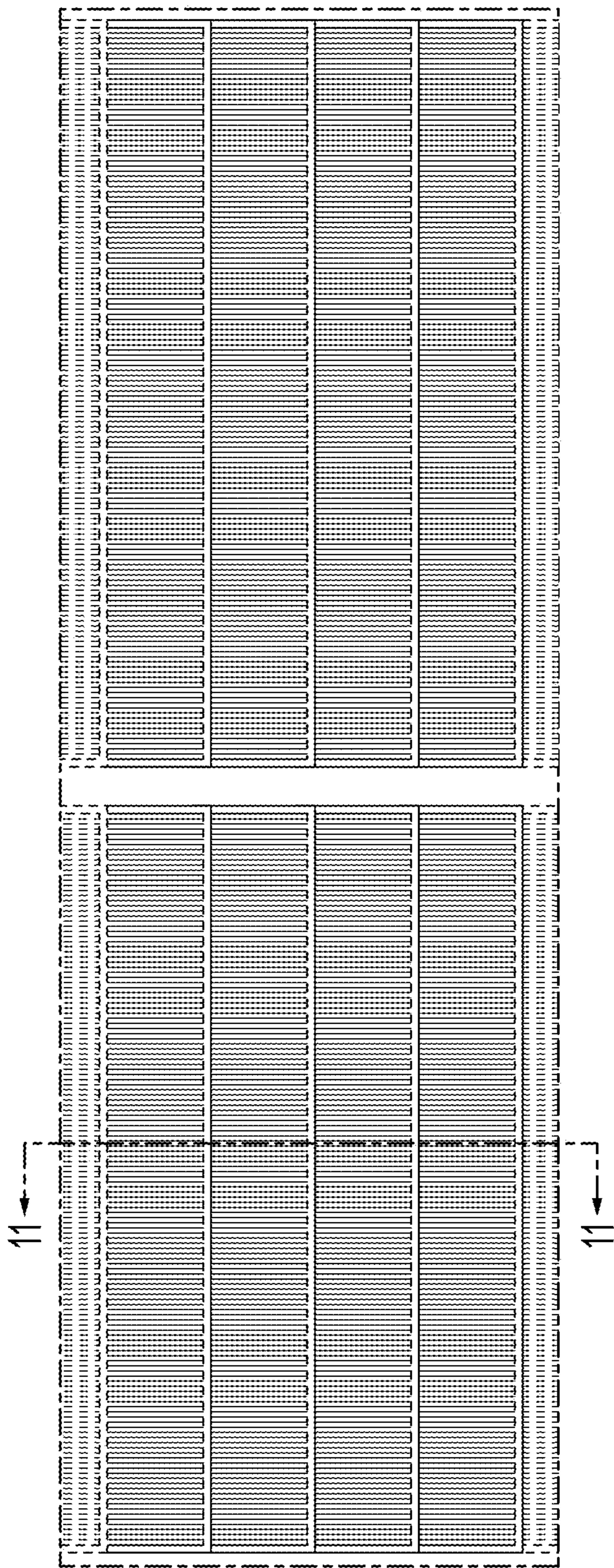


FIG. 10



FIG. 11

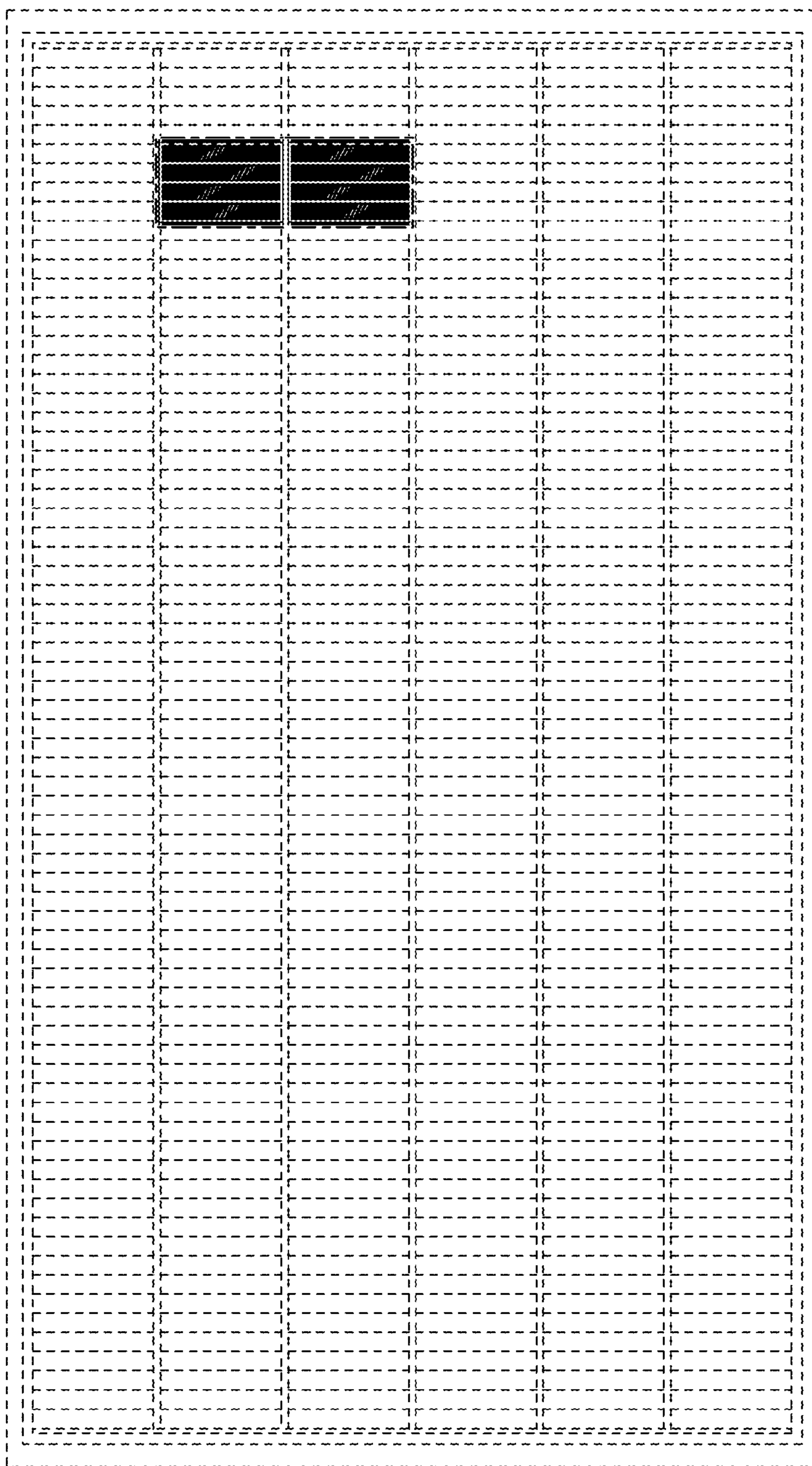


FIG. 12

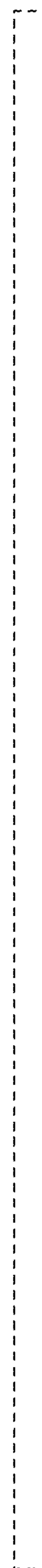


FIG. 14

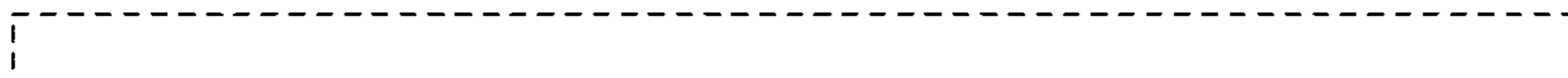


FIG. 13

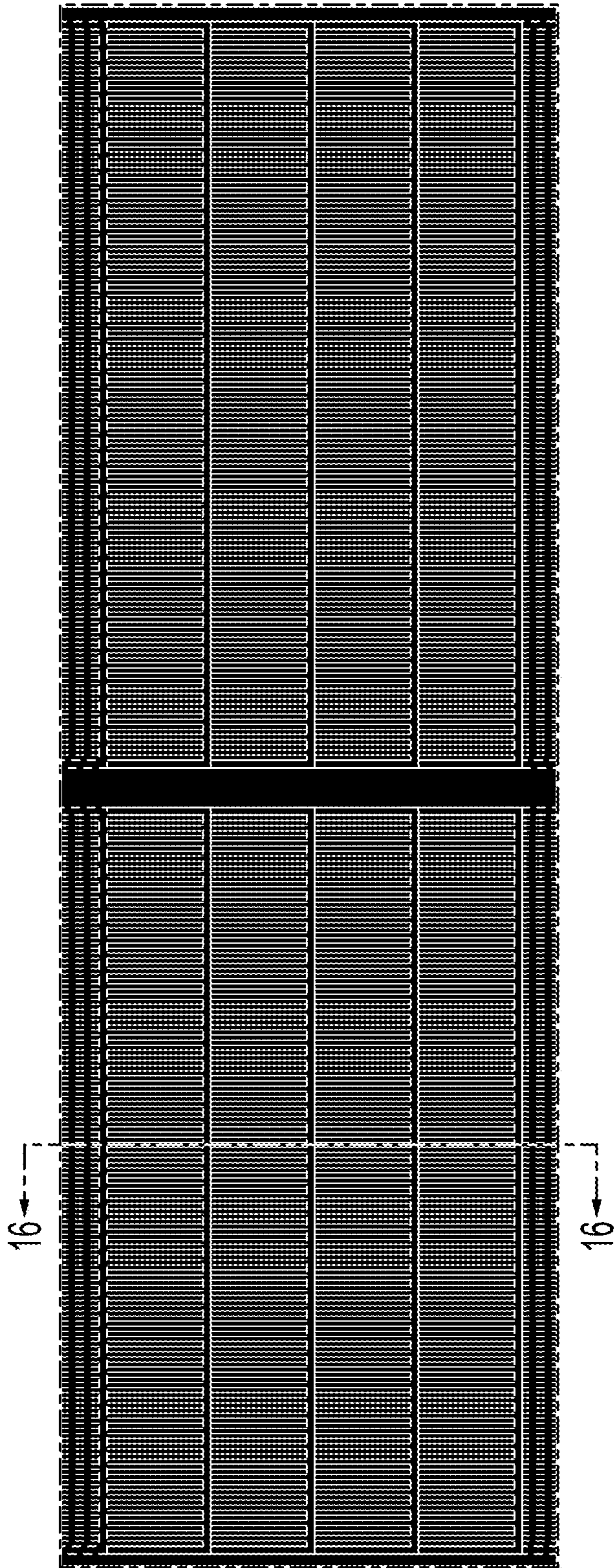


FIG. 15



FIG. 16